

Water Cooling Head Water Cooling Plate

NA567

1 water-cooled head use: semiconductor refrigeration chip exclusive water-cooled head, liquid-cooled water plate, water-cooled exchanger, positive and negative are plane right angle, with the refrigeration chip completely coincides with the semiconductor refrigeration chip tailor-made for heat dissipation, cold transfer, cold water formation, etc. production!

2. Material: aluminium, one-piece welding

3. Pagoda nozzle: 9.2mm external diameter (can be connected to the inner diameter of 7-8mm soft water pipe), length 15mm (hand-measurement)

4. Throw very smooth, zero distance contact with the pistil, good heat absorption effect

5.Thickness 12mm